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Analog-to-Digital Converters

Operation of a SAR-ADC Based on Charge Redistribution

Abstract

Analog-to-Digital Converters (ADCs) that convert the sampled input signal through Successive Approximation (SAR), are known as SAR-ADCs. While there are various methods of performing successive approximation, Renesas SAR-ADCs use a method known as capacitive charge redistribution.

This application note explains the functional principle of a SAR-ADC based on charge redistribution

Contents

1.	Introduction	2
2.	Sample Mode	2
3.	Hold Mode	3
4.	Redistribution Mode	3
5.	Conversion Example	4
6.	Timing Diagram	6
7.	Revision History	7

List of Figures

Figure 1.	Simplified 5-Bit SAR-ADC Principle	2
Figure 2.	Sample Mode	2
Figure 3.	Hold Mode	3
Figure 4.	Conversion Step 1 Determines the MSB (Bit 4)	3
Figure 5.	Sample Mode: All Capacitors are Charged up to V _{IN} = +3V	4
Figure 6.	Hold Mode: All Capacitors are Charged up to V_{IN} = +3V	4
Figure 7.	Bit-4 (MSB): Because V_0 = H, Bit 4 = 1. Therefore, S_4 Must Remain in its Current Position	5
Figure 8.	Bit-3: Because V_0 = L, Bit 3 = 0. Therefore, S ₃ Must be Switched Back to GND	5
Figure 9.	Bit-2: Because $V_0 = L$, Bit 2 = 0. Therefore, S_2 Must be Switched Back to GND	5
Figure 10.	Bit 1: Because V_0 = H, Bit 1 = 1. Therefore, S ₁ Must Remain in its Current Position	6
Figure 11.	Bit 0: Because V_0 = H, Bit 0 = 1. Therefore, S ₀ Must Remain in its Current Position	6
Figure 12.	SAR Conversion Timing Diagram	6

Related Literature

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1. Introduction

<u>Figure 1</u> shows the simplified, switched-capacitor structure of a 5-bit SAR-ADC. The capacitor values are binary weighted from C, C/2 ...C/16 or C/2ⁿ⁻¹. The last two capacitors have the same value of C/2ⁿ⁻¹. Only the first capacitor (connected to S₀) is switched during the charge redistribution (the actual conversion). The other capacitor remains connected to ground.

MOS-transistors implement the required n+3 switches, and the voltage comparator provides the appropriate steering of these switches using auxiliary logic circuitry.

The conversion process is performed in three steps:

- Sample mode
- · Hold mode
- · Redistribution mode (the actual conversion)



Figure 1. Simplified 5-Bit SAR-ADC Principle

2. Sample Mode

In the sampling mode (Figure 2), bus switch SB is switched to the input voltage, V_{IN} , and S_A is closed to ground. The capacitor switches, $S_4...S_0$ ', are turned to the common bus B and all capacitors are charged to V_{IN} . The total charge of $Q_{IN} = V_{IN} \cdot 2C$ is stored on the left plates of the capacitors.



Figure 2. Sample Mode



3. Hold Mode

During the hold mode (Figure 3), switch S_A is open while the switches $S_4...S_0$ ' are connected to ground, thereby making the voltage at the inverting comparator input $V_C = -V_{IN}$. This means that the switched-cap circuit already has a built-in sample-and-hold function.



Figure 3. Hold Mode

4. Redistribution Mode

The actual conversion is performed by charge redistribution. The first conversion step, shown in Figure 4, connects C (the largest capacitor) using S_4 to the reference voltage V_{REF} , which corresponds to the Full-Scale Range (FSR) of the ADC.



Figure 4. Conversion Step 1 Determines the MSB (Bit 4)

Capacitor C forms a 1:1 capacitance divider with the remaining capacitors connected to ground. The comparator input voltage becomes $V_C = -V_{IN} + V_{REF}/2$. This voltage is compared with the voltage potential of 0V at the non-inverting input. Therefore, if $|V_{IN}| > V_{REF}/2$, $V_C < 0$, and the comparator output V_O goes high, setting the Most Significant Bit (MSB) (Bit 4) = 1. However, if $|V_{IN}| < V_{REF}/2$, $V_C > 0$, V_O remains low, and Bit 4 = 0. If V_O = high, S_4 remains connected to V_{REF} for the rest of the conversion. If V_O = low, S_4 is switched back to GND.

This procedure is repeated for switches, S3 to S0, except S0', which remains connected to GND for the entire conversion.

Summarizing, the conversion or charge redistribution procedure can be expressed by two equations:

(EQ. 1) If $-V_{IN} + V_{REF} \cdot X > 0 \implies V_O = \text{High} [1] \implies \text{maintain switch position}$

(EQ. 2) If $-V_{IN} + V_{REF} \cdot X < 0 \implies V_O = Low[0] \implies \text{connect switch back to GND}$

with X as the ratio of the capacitive voltage divider because of a given switch position.

Therefore, the comparator input voltage of the final conversion step is:

$$(\textbf{EQ. 3}) \qquad V_{C} = -V_{IN} + bit \ 4 \cdot \frac{V_{REF}}{2} + bit \ 3 \cdot \frac{V_{REF}}{4} + bit \ 2 \cdot \frac{V_{REF}}{8} + bit \ 1 \cdot \frac{V_{REF}}{16} + bit \ 0 \cdot \frac{V_{REF}}{32}$$

5. Conversion Example

The following example shows the conversion process of a 5-bit SAR-ADC for V_{IN} = 3V and V_{REF} = 5V. According to Equation 3, the comparator input voltage of the final conversion step must be:

(EQ. 4) $V_{C} = -3V + [1] \cdot 2.5V + [0] \cdot 1.25V + [0] \cdot 0.625V + [1] \cdot 0.3125V + [1] \cdot 0.15625V = -0.03125V$

Sample Mode: All capacitors are connected to voltage bus B using S₄ to S₀' and to ground using S_A. Bus B is connected to V_{IN}. All capacitors are charged up to V_{IN} = 3V (<u>Figure 5</u>).



Figure 5. Sample Mode: All Capacitors are Charged up to V_{IN} = +3V

Hold Mode: The left side of the capacitors is connected to ground using S₄ to S₀'. The common (right) side of the capacitors is disconnected from ground using S_A, therefore, creating a comparator input voltage of $-V_{IN} = -3V$ (Figure 6).



Figure 6. Hold Mode: All Capacitors are Charged up to V_{IN} = +3V

Redistribution Mode: The actual conversion starts by connecting S_B to V_{REF} = 5V.

Bit 4 (MSB): The first conversion step determines the most significant bit (MSB = Bit 4) connecting C to V_{REF} using S₄. The ratio of the capacitive voltage divider becomes X = 1/2 and creates a comparator input voltage of V_C = -0.5V. This turns the comparator output high and sets Bit 4 to 1. It also means that S₄ must remain in the present position for the rest of the conversion process (Figure 7).

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Figure 7. Bit-4 (MSB): Because V_O = H, Bit 4 = 1. Therefore, S₄ Must Remain in its Current Position

Bit 3: The second conversion step determines Bit 3 by connecting C/2 to V_{REF} using S₃. The divider ratio changes to X = ${}^{3}/_{4}$, causing a comparator input of V_C = +0.75V. This turns the comparator output low and sets Bit 3 to 0. It also means that S₃ must be switched back to ground (<u>Figure 8</u>).



Figure 8. Bit-3: Because $V_0 = L$, Bit 3 = 0. Therefore, S₃ Must be Switched Back to GND

Bit 2: The third conversion step determines Bit 2 by connecting C/4 to V_{REF} using S₂. The divider ratio changes to X = ${}^{5}\!/_{8}$, causing a comparator input of V_C = +0.125V. This turns the comparator output low and sets Bit 2 to 0. It also means that S₂ must be switched back to ground (<u>Figure 9</u>).



Figure 9. Bit-2: Because $V_0 = L$, Bit 2 = 0. Therefore, S_2 Must be Switched Back to GND

Bit 1: The fourth conversion step determines Bit 1 by connecting C/8 to V_{REF} using S₁. The divider ratio changes to X = ${}^{9}/_{16}$, causing a comparator input of V_C = -0.1875V. This turns the comparator output high and sets Bit 1 to 1. It also means that S₁ must remain in the present position for the rest of the conversion process (Figure 10).





Figure 10. Bit 1: Because V_0 = H, Bit 1 = 1. Therefore, S₁ Must Remain in its Current Position

Bit 0: The fifth conversion step determines Bit 0 by connecting C/16 to V_{REF} using S₀. The divider ratio changes to X = ¹⁹/₃₂, causing a comparator input of V_C = -0.03125V. This turns the comparator output high and sets Bit 0 to 1. It also means that S₀ must remain in the present position (<u>Figure 11</u>).



Figure 11. Bit 0: Because V_O = H, Bit 0 = 1. Therefore, S₀ Must Remain in its Current Position

6. Timing Diagram

<u>Figure 12</u> shows the timing diagrams for the bus voltage (V_B) the comparator input voltage (V_C) the On/Off status of all switches (1 = On), and the individual capacitor voltages, V_{C1} to V_{C16} '.



Figure 12. SAR Conversion Timing Diagram



7. Revision History

Rev.	Date	Description
1.00	Sep.17.20	Initial release



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